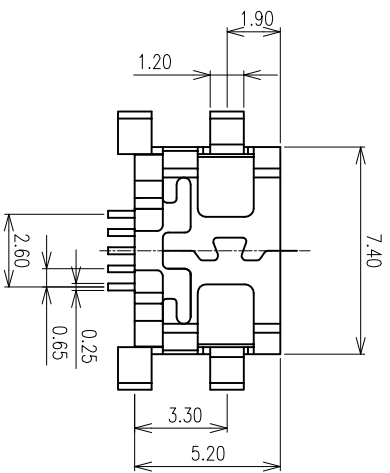


RECOMMEND P.C.B LAYOUT



NOTES:

1. MATERIAL:
  - 1.1 HOUSING: THERMOPLASTIC FLAMMABILITY RATING UL94V-0
  - 1.2 CONTACT: COPPER ALLOY T=0.15mm
  - 1.3 SHELL: STAINLESS STEEL T=0.30mm
2. FINISH:
  - 2.1 CONTACT:
    - 3u" MIN. PLATED ON CONTACT AREA
    - G/F PLATING ON SOLDER TAIL AREA
    - 50~80u" NICKEL UNDERPLATING OVERALL
  - 2.2 SHELL:
    - 80~120 u" WATER TIN PLATING ALL
    - 50~80u" NICKEL UNDERPLATING OVERALL
3. SPECIFICATION:
  - 3.1 CURRENT RATING: 0.5A(2.34CONTACT)/1.8A(1.5CONTACT) MAX.
  - 3.2 VOLTAGE: 30 VAC
  - 3.3 TEMPERATURE RANGE: -30 °C ~ 85 °C
  - 3.4 CONTACT RESISTANCE: 30 MILLIONHM MAX.
  - 3.5 DIELECTRIC WITHSTANDING VOLTAGE: 250 VAC r.m.s
  - 3.6 INSULATION RESISTANCE: 100 MEGOHMS MIN

3	SHELL	SUS304R-H T=0.30mm	TIN/NI Plated	TPCS
2	CONTACT	C2680R-H T=0.15mm	Au/NI Plated	TSET
1	HOUSING	PART U94V-0	BLACK	TPCS
NO.	DESCRIPTION	MATERIAL	REMARKS	QTY

**CSCONN**

CSCONN PRECISE ELECTRONICS CO.,LTD

UNITS: mm		PART NO.(INTENDED USE)		TITLE:	MICRO USB 5P DIP 沉板0.7MM
GENERAL TOLERANCES		CMLU065503003			
X. ±5°	0.X±0.25	APPD:	SKi1a	DWG NO.	MICRO USB
X.1±2°	0.XX±0.2	CHKD:	DR:	SCALE	SHEET
XX ±1°	0.XXX±0.1		Kitty	1:1	1 OF 1
					REV
					A

